



# Product Change Notification

**Change Notification #:** 118054 - 00  
**Change Title:** Select Intel® SSD D5-P4320 Series,  
Intel® SSD D5-P4326 Series,  
Intel® SSD D5-P4420 Series,  
Intel® SSD DC P4510 Series, and  
Intel® SSD DC P4610 Series SKUs,  
PCN 118054-00, Transport Media, Product  
Material, Shipping Packaging Media Change  
from ESD Bag to Clamshell  
**Date of Publication:** January 26, 2021

## Key Characteristics of the Change:

Transport Media, Product Material

## Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	March 27, 2021
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## Description of Change to the Customer:

The Intel® SSD Series SKUs listed in the Products Affected Table below will have the following changes.

The current ESD based Packaging Kit(s) will be replaced with the Clamshell based Packaging Kit(s).

- Change 1 – Single Form Factor 156mm SSD Individual Packaging
- Change 2 – MOQ 1, Shipping Box Packaging
- Change 3 – MOQ 10, Shipping Box Packaging

## Affected SKUs by MM#

Change 1	Change 2	Change 3
959391	979184	979158
959393	984815	984816
959395	984817	984818
959397	984819	984820
963520	984821	984822
978083	984823	984824
978084	986512	986513
978085	999DXN	
979157		

## Single SFF 15mm SSD Packaging

Current Packaging – Affects all Change 1, 2, and 3 SKUs



New Packaging – Affects all Change 1, 2, and 3 SKUs



## MOQ1 – Shipping Box

Affects Change 1 SKUs

Shipping Qty	Current Shipping Box	Current Shipping Box Size	New Shipping Box	New Shipping Box Size
Full box (50u SSD)		480 x 250 x 160 (mm)		440 x 330 x 140 (mm)
Partial Box (1-49u SSD)		233 x 163 x 136 (mm) 1-12u: 1 box 1-24u: 2 boxes 1-36u: 3 boxes 1-48u: 4 boxes 1-49u: 5 boxes		233 x 163 x 136 (mm) 1-14u: 1 box 1-28u: 2 boxes 1-42u: 3 boxes 1-49u: 4 boxes

## MOQ10 – Shipping Box

Affects Change 2 and 3 SKUs

Shipping Box Size (L+W+H)	Current Shipping Box	Current Shipping Box Size (Outer)	New Shipping Box	New Shipping Box Size (Outer)
< 600mm MOQ10 Pkg Kit J48017-002 Change 2	 	Shipping box contains 1-4 MOQ10 boxes. <b>Big shipping box: 410 x 270 x 180 (mm)</b>	 	<b>244 x 223 x 161 (mm)</b>
600mm MOQ10 Pkg Kit J84458-001 Change 3		260 x 200 x 170 (mm)		

## **Customer Impact of Change and Recommended Action:**

There is no change to the Form, Fit, or Function of the product. The change is only to the packaging.

Customers should be aware of the changes to the packaging and take appropriate actions to accommodate the changes and avoid impact to their process.

Milestone dates are estimates and subject to change based on business and operational conditions.

Please contact your local Intel Field Sales Rep if you have any further questions about these changes.

## **Products Affected / Intel Ordering Codes:**

Marketing Name	Product Code	MM#
Intel® SSD DC P4510 Series (1.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic Single Pack	SSDP-E2KX010T801	959391
Intel® SSD DC P4510 Series (2.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic Single Pack	SSDP-E2KX020T801	959393
Intel® SSD DC P4510 Series (4.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic Single Pack	SSDP-E2KX040T801	959395
Intel® SSD DC P4510 Series (8.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic Single Pack	SSDP-E2KX080T801	959397
Intel® SSD DC P4610 Series (7.6TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic Single Pack	SSDP-E2KE076T801	963520
Intel® SSD DC P4610 Series (1.6TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic Single Pack	SSDP-E2KE016T801	978083
Intel® SSD DC P4610 Series (3.2TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic Single Pack	SSDP-E2KE032T801	978084
Intel® SSD DC P4610 Series (6.4TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic Single Pack	SSDP-E2KE064T801	978085
Intel® SSD D5-P4320 Series (7.68TB, 2.5in, PCIe 3.1 x4, 3D2, QLC) Generic Single Pack	SSDP-E2NV076T801	979157
Intel® SSD D5-P4326 Series (15.3TB, 2.5in PCIe 3.1 x4, 3D2, QLC) Generic Single Pack	SSDP-E2NV153T801	979184
Intel® SSD DC P4510 Series (1.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic Single Pack OPAL	SSDP-E2KX010T8OS	984815
Intel® SSD DC P4510 Series (2.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic Single Pack OPAL	SSDP-E2KX020T8OS	984817
Intel® SSD DC P4510 Series (4.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic Single Pack OPAL	SSDP-E2KX040T8OS	984819
Intel® SSD DC P4610 Series (1.6TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic Single Pack OPAL	SSDP-E2KE016T8OS	984821
Intel® SSD DC P4610 Series (3.2TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic Single Pack OPAL	SSDP-E2KE032T8OS	984823
Intel® SSD DC P4510 Series (8.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic Single Pack OPAL	SSDP-E2KX080T8OS	986512
Intel® SSD D5-P4420 Series (7.68TB, 2.5in, PCIe 3.1 x4, 3D2, QLC) Generic Single Pack	SSDP-E2NU076T801	999DXN
Intel® SSD D5-P4320 Series (7.68TB, 2.5in, PCIe 3.1 x4, 3D2, QLC) Generic 10 Pack	SSDP-E2NV076T810	979158
Intel® SSD DC P4510 Series (1.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic 10 Pack OPAL	SSDP-E2KX010T8OP	984816
Intel® SSD DC P4510 Series (2.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic 10 Pack OPAL	SSDP-E2KX020T8OP	984818
Intel® SSD DC P4510 Series (4.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic 10 Pack OPAL	SSDP-E2KX040T8OP	984820
Intel® SSD DC P4610 Series (1.6TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic 10 Pack OPAL	SSDP-E2KE016T8OP	984822
Intel® SSD DC P4610 Series (3.2TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic 10 Pack OPAL	SSDP-E2KE032T8OP	984824
Intel® SSD DC P4510 Series (8.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic 10 Pack OPAL	SSDP-E2KX080T8OP	986513
Intel® SSD DC P4510 Series (1.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic 10 Pack	SSDP-E2KX010T810	959392
Intel® SSD DC P4510 Series (2.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic 10 Pack	SSDP-E2KX020T810	959394
Intel® SSD DC P4510 Series (4.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic 10 Pack	SSDP-E2KX040T810	959396
Intel® SSD DC P4510 Series (8.0TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic 10 Pack	SSDP-E2KX080T810	959398
Intel® SSD DC P4510 Series (1.9TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic 10 Pack	SSDP-E2KX019T810	99A9RV
Intel® SSD DC P4510 Series (3.8TB, 2.5in PCIe 3.1 x4, 3D2, TLC) Generic 10 Pack	SSDP-E2KX038T810	99A9RW

## **PCN Revision History:**

Date of Revision:

January 26, 2021

Revision Number:

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Reason:

Originally Published PCN



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## 118054 - 00

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